

This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF THE CLAIMS:

1. (Currently amended) A capacitor, comprising:
  - a fixed charge plate disposed on a semiconductor substrate;
  - a fixed actuator plate disposed upon the semiconductor substrate;
  - a moveable charge plate disposed above the fixed charge plate, wherein the fixed charge plate has a first surface area and the movable charge plate has a second surface area that is smaller than the first surface area;
  - a stiffener disposed on a center portion of the moveable charge plate; and
  - a movable actuator plate disposed over the fixed actuator plate.
2. (Original) The capacitor according to claim 1, the movable charge plate further comprising:
  - a first separation distance between the fixed charge plate and the stiffener, wherein the first separation distance is constant.
3. (Original) The capacitor according to claim 1, further comprising:
  - a first separation distance between the fixed charge plate and the stiffener, wherein the first separation distance is constant; and
  - a second separation distance between the fixed charge plate and portions of the movable charge plate, wherein the second separation distance is variable.
4. (Canceled)
5. (Original) The capacitor according to claim 1, wherein the movable charge plate comprises a solid surface plate and a broken surface suspension.

6. (Original) The capacitor according to claim 1, wherein the movable charge plate comprises a solid surface plate and a broken surface suspension, and wherein the broken surface suspension has an undulating configuration.

7. (Currently amended) The capacitor according to claim 1, ~~wherein the fixed charge plate has a first surface area and the movable charge plate has a second surface area that is smaller than the first surface area,~~ and wherein the movable charge plate comprises a solid surface plate and a broken surface suspension.

8. (Currently amended) The capacitor according to claim ~~7~~ 1, ~~wherein the fixed charge plate has a first surface area and the movable charge plate has a second surface area that is smaller than the first surface area, wherein the movable charge plate comprises a solid surface plate and a broken surface suspension,~~ and wherein the broken surface suspension has an undulating configuration.

9.-16. (Canceled)

17. (Currently amended) A microelectromechanical structure variable capacitor comprising:

a fixed charge plate disposed upon an elevated semiconductor substrate;

a fixed actuator plate disposed upon a lower semiconductor substrate,

wherein the fixed actuator plate is below the fixed charge plate;

a moveable charge plate suspended above the fixed charge plate, wherein the fixed charge plate has a first surface area and the movable charge plate has a second surface area that is smaller than the fixed charge plate;

a stiffener disposed upon a center portion of the moveable charge plate;

and

a movable actuator plate disposed over the fixed actuator plate.

18. (Canceled)

19. (Original) The microelectromechanical structure variable capacitor according to claim 17, wherein the movable charge plate comprises a solid surface plate and a broken surface suspension.

20. (Cancelled)

21. (Original) The microelectromechanical structure variable capacitor according to claim 17, wherein the elevated substrate and the lower substrate have a negligible elevational difference.